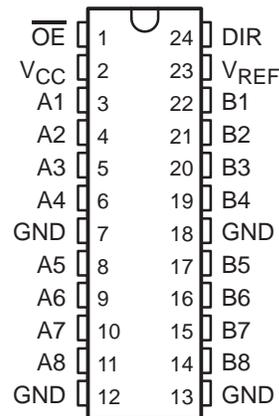


# SN74GTLPH306 8-BIT LVTTTL-TO-GTL+ BUS TRANSCEIVER

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- Bidirectional Interface Between GTL+ Signal Levels and LVTTTL Logic Levels
- Equivalent to '245 Function
- LVTTTL Interfaces Are 5-V Tolerant
- Medium-Drive GTL+ Outputs (50 mA)
- LVTTTL Outputs (–24 mA/24 mA)
- GTL+ Rise and Fall Times Designed for Optimal Data-Transfer Rate and Signal Integrity
- $I_{off}$  and Power-Up 3-State Support Hot Insertion
- Bus Hold on A-Port Data Inputs
- Package Options Include Plastic Small-Outline (DW), Thin Very Small-Outline (DGV), and Thin Shrink Small-Outline (PW) Packages

DGV, DW, OR PW PACKAGE  
(TOP VIEW)



## description

The SN74GTLPH306 is a medium-drive 8-bit bus transceiver that provides LVTTTL-to-GTL+ and GTL+-to-LVTTTL signal-level translation. It is equivalent to the '245 function. The device provides a high-speed interface between cards operating at LVTTTL-logic levels and a backplane operating at GTL+-signal levels. High-speed (about two times faster than standard LVTTTL or TTL) backplane operation is a direct result of GTLP's reduced output swing (<1 V), reduced input threshold levels, improved differential input, and output edge control (OEC™). Improved GTLP OEC circuits minimize bus settling time and have been designed and tested using several backplane models. The medium drive is suitable for driving double-terminated backplanes.

GTL+ is the Texas Instruments derivative of the Gunning transceiver logic (GTL) JEDEC standard JESD 8-3. The AC specification of the SN74GTLPH306 is given only at the preferred higher noise margin GTL+, but the user has the flexibility of using this device at either GTL ( $V_{TT} = 1.2$  V and  $V_{REF} = 0.8$  V) or GTL+ ( $V_{TT} = 1.5$  V and  $V_{REF} = 1$  V) signal levels.

Normally, the B port operates at GTL or GTL+ levels, while the A-port and control inputs are compatible with LVTTTL logic levels and are 5-V tolerant.  $V_{REF}$  is the reference input voltage for the B port.

This device is fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

Active bus-hold circuitry holds unused or undriven LVTTTL inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the device is in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V, the output-enable ( $\overline{OE}$ ) input should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74GTLPH306 is characterized for operation from –40°C to 85°C.



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# SN74GTLPH306

## 8-BIT LVTTTL-TO-GTL+ BUS TRANSCEIVER

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### functional description

The SN74GTLPH306 is an 8-bit bus transceiver, providing standard '245 functionality, and is designed for asynchronous communication between data buses. The device transmits data from the A port to the B port or from the B port to the A port, depending on the logic level at the direction-control (DIR) input.  $\overline{OE}$  can be used to disable the device so the buses are effectively isolated. Data polarity is noninverting.

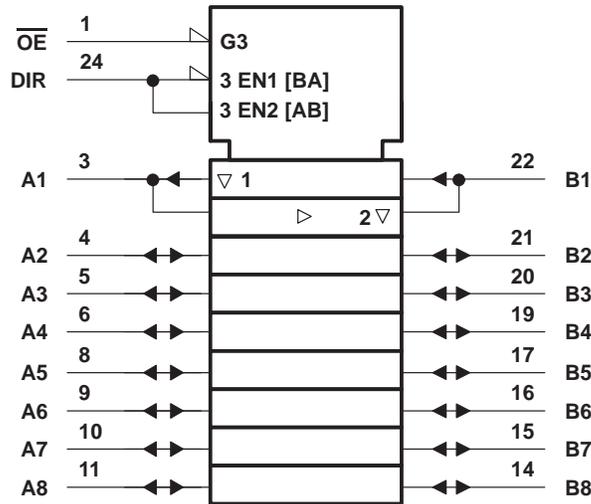
For A-to-B data flow, when  $\overline{OE}$  is low and DIR is high, the B outputs take on the logic value of the A inputs. When  $\overline{OE}$  is high, the outputs are in the high-impedance state.

Data flow for B to A is similar to that for A to B, but  $\overline{OE}$  is low and DIR is low.

FUNCTION TABLE

INPUTS		OUTPUT	MODE
$\overline{OE}$	DIR		
L	L	B data to A port	Transparent
L	H	A data to B port	Transparent
H	X	Z	Isolation

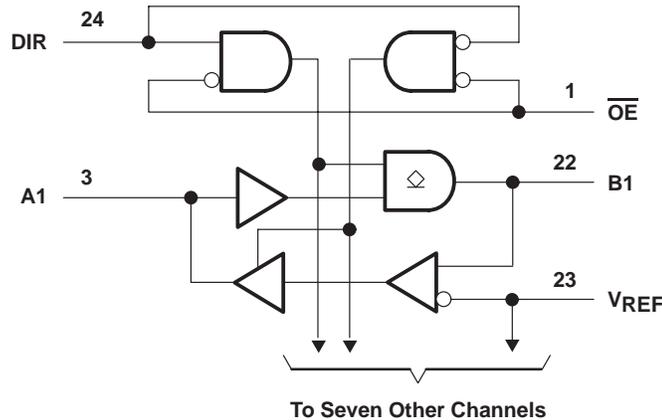
### logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

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logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, $V_{CC}$ .....	-0.5 V to 7 V
Input voltage range, $V_I$ (see Note 1): A-port and control inputs .....	-0.5 V to 7 V
B port and $V_{REF}$ .....	-0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1): A port .....	-0.5 V to 7 V
B port .....	-0.5 V to 7 V
Voltage range applied to any output in the high or low state, $V_O$ (see Note 1): A port .....	-0.5 V to $V_{CC} + 0.5$ V
B port .....	-0.5 V to 4.6 V
Current into any output in the low state, $I_O$ : A port .....	48 mA
B port .....	100 mA
Current into any A-port output in the high state, $I_O$ (see Note 2) .....	48 mA
Continuous current through each $V_{CC}$ or GND .....	$\pm 100$ mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ ) .....	-50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ ) .....	-50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DGV package .....	86°C/W
DW package .....	46°C/W
PW package .....	88°C/W
Storage temperature range, $T_{stg}$ .....	-65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.  
2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .  
3. The package thermal impedance is calculated in accordance with JESD 51.

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# SN74GTLPH306

## 8-BIT LVTTTL-TO-GTL+ BUS TRANSCEIVER

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### recommended operating conditions (see Notes 4 through 6)

		MIN	NOM	MAX	UNIT	
V <sub>CC</sub>	Supply voltage	3.15	3.3	3.45	V	
V <sub>TT</sub>	Termination voltage	GTL	1.14	1.2	1.26	V
		GTL+	1.35	1.5	1.65	
V <sub>REF</sub>	Supply voltage	GTL	0.74	0.8	0.87	V
		GTL+	0.87	1	1.1	
V <sub>I</sub>	Input voltage	B port	V <sub>TT</sub>		V	
		Except B port	V <sub>CC</sub>			
V <sub>IH</sub>	High-level input voltage	B port	V <sub>REF</sub> +0.05		V	
		Except B port	2			
V <sub>IL</sub>	Low-level input voltage	B port	V <sub>REF</sub> -0.05		V	
		Except B port	0.8			
I <sub>IK</sub>	Input clamp current			-18	mA	
I <sub>OH</sub>	High-level output current	A port			-24	mA
I <sub>OL</sub>	Low-level output current	A port			24	mA
		B port			50	
T <sub>A</sub>	Operating free-air temperature			-40	85	°C

- NOTES:
- All unused control and B-port inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
  - Normal connection sequence is GND first and V<sub>CC</sub> = 3.3 V, I/O, control inputs, V<sub>TT</sub> and V<sub>REF</sub> (any order) last.
  - V<sub>TT</sub> and R<sub>TT</sub> can be adjusted to accommodate backplane impedances as long as they do not exceed the DC absolute I<sub>OL</sub> ratings. Similarly, V<sub>REF</sub> can be adjusted to optimize noise margins, but normally is 2/3 V<sub>TT</sub>.

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electrical characteristics over recommended operating free-air temperature range for GTL+ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
$V_{IK}$		$V_{CC} = 3.15\text{ V}$ , $I_I = -18\text{ mA}$				-1.2	V	
$V_{OH}$	A port	$V_{CC} = 3.15\text{ V to } 3.45\text{ V}$ , $I_{OH} = -100\text{ }\mu\text{A}$		$V_{CC}-0.2$			V	
		$V_{CC} = 3.15\text{ V}$ , $I_{OH} = -12\text{ mA}$		2.4				
		$V_{CC} = 3.15\text{ V}$ , $I_{OH} = -24\text{ mA}$		2				
$V_{OL}$	A port	$V_{CC} = 3.15\text{ V to } 3.45\text{ V}$ , $I_{OL} = 100\text{ }\mu\text{A}$				0.2	V	
		$V_{CC} = 3.15\text{ V}$ , $I_{OL} = 12\text{ mA}$				0.4		
		$V_{CC} = 3.15\text{ V}$ , $I_{OL} = 24\text{ mA}$				0.5		
	B port	$V_{CC} = 3.15\text{ V}$ , $I_{OL} = 40\text{ mA}$				0.4		
		$V_{CC} = 3.15\text{ V}$ , $I_{OL} = 50\text{ mA}$				0.55		
$I_I^\ddagger$	B port	$V_{CC} = 3.45\text{ V}$ , $V_I = 0\text{ to } 1.5\text{ V}$				$\pm 5$	$\mu\text{A}$	
	Control inputs	$V_{CC} = 3.45\text{ V}$ , $V_I = 0\text{ or } 5.5\text{ V}$				$\pm 5$		
	A port	$V_{CC} = 3.45\text{ V}$ , $V_I = 0\text{ or } 5.5\text{ V}$				$\pm 20$		
$I_{BHL}^\S$	A port	$V_{CC} = 3.15\text{ V}$ , $V_I = 0.8\text{ V}$		75			$\mu\text{A}$	
$I_{BHH}^\parallel$	A port	$V_{CC} = 3.15\text{ V}$ , $V_I = 2\text{ V}$		-75			$\mu\text{A}$	
$I_{BHLO}^\#$	A port	$V_{CC} = 3.45\text{ V}$ , $V_I = 0\text{ to } V_{CC}$				500	$\mu\text{A}$	
$I_{BHHO}^\parallel$	A port	$V_{CC} = 3.45\text{ V}$ , $V_I = 0\text{ to } V_{CC}$				-500	$\mu\text{A}$	
$I_{CC}$	A or B port	$V_{CC} = 3.45\text{ V}$ , $I_O = 0$ , $V_I$ (A-port or control input) = $V_{CC}$ or GND $V_I$ (B port) = $V_{TT}$ or GND		Outputs high		7	18	mA
				Outputs low		8	20	
				Outputs disabled		8	20	
$\Delta I_{CC}^\star$		$V_{CC} = 3.45\text{ V}$ , One A-port or control input at $V_{CC} - 0.6\text{ V}$ , Other A-port or control inputs at $V_{CC}$ or GND				1.5	mA	
$C_i$	Control inputs	$V_I = 3.15\text{ V or } 0$					pF	
$C_{io}$	A port	$V_O = 3.15\text{ V or } 0$					pF	
	B port	$V_O = 1.5\text{ V or } 0$						

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ For I/O ports, the parameter  $I_I$  includes the off-state output leakage current.

§ The bus-hold circuit can sink at least the minimum low sustaining current at  $V_{ILmax}$ .  $I_{BHL}$  should be measured after lowering  $V_{IN}$  to GND and then raising it to  $V_{ILmax}$ .

¶ The bus-hold circuit can source at least the minimum high sustaining current at  $V_{IHmin}$ .  $I_{BHH}$  should be measured after raising  $V_{IN}$  to  $V_{CC}$  and then lowering it to  $V_{IHmin}$ .

# An external driver must source at least  $I_{BHLO}$  to switch this node from low to high.

|| An external driver must sink at least  $I_{BHHO}$  to switch this node from high to low.

\*This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

hot-insertion specifications for A port over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
$I_{off}$	$V_{CC} = 0$ ,	$V_I$ or $V_O = 0\text{ to } 5.5\text{ V}$		100	$\mu\text{A}$
$I_{OZPU}$	$V_{CC} = 0\text{ to } 1.5\text{ V}$ ,	$V_O = 0.5\text{ V to } 3\text{ V}$ , $\overline{OE} = 0$		$\pm 100$	$\mu\text{A}$
$I_{OZPD}$	$V_{CC} = 1.5\text{ V to } 0$ ,	$V_O = 0.5\text{ V to } 3\text{ V}$ , $\overline{OE} = 0$		$\pm 100$	$\mu\text{A}$

hot-insertion specifications for B port over recommended operating free-air temperature range

PARAMETER	TEST CONDITIONS		MIN	MAX	UNIT
$I_{off}$	$V_{CC} = 0$ ,	$V_I$ or $V_O = 0\text{ to } 1.5\text{ V}$		100	$\mu\text{A}$
$I_{OZPU}$	$V_{CC} = 0\text{ to } 1.5\text{ V}$ ,	$V_O = 0.5\text{ V to } 1.5\text{ V}$ , $\overline{OE} = 0$		$\pm 100$	$\mu\text{A}$
$I_{OZPD}$	$V_{CC} = 1.5\text{ V to } 0$ ,	$V_O = 0.5\text{ V to } 1.5\text{ V}$ , $\overline{OE} = 0$		$\pm 100$	$\mu\text{A}$



# SN74GTLPH306

## 8-BIT LVTTTL-TO-GTL+ BUS TRANSCEIVER

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switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.5\text{ V}$  and  $V_{REF} = 1\text{ V}$  for GTL+ (see Figure 1)

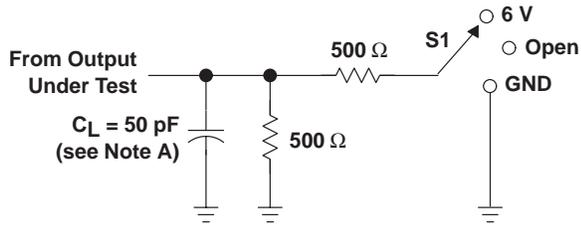
PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	TYP†	MAX	UNIT
$t_{PHL}$	A	B				ns
$t_{PLH}$						
$t_{en}$	$\overline{OE}$	B				ns
$t_{dis}$						
$t_r$	Rise time, B outputs (20% to 80%)					ns
$t_f$	Fall time, B outputs (80% to 20%)					ns
$t_r$	Rise time, A outputs (10% to 90%)					ns
$t_f$	Fall time, A outputs (90% to 10%)					ns
$t_{PHL}$	B	A				ns
$t_{PLH}$						
$t_{en}$	$\overline{OE}$	A				ns
$t_{dis}$						

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

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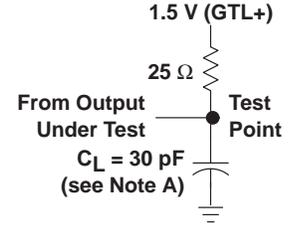


PARAMETER MEASUREMENT INFORMATION

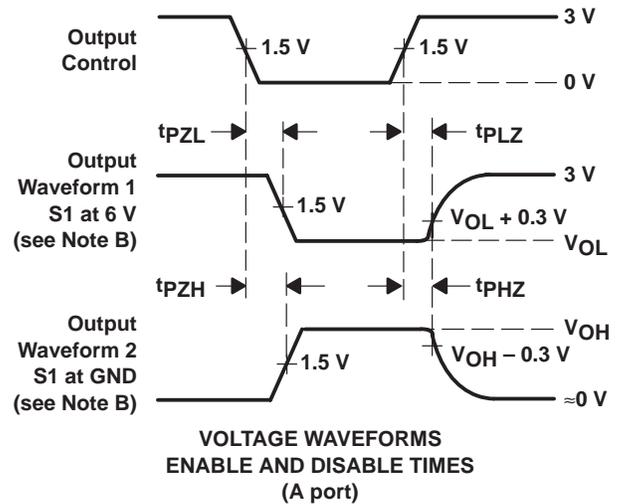
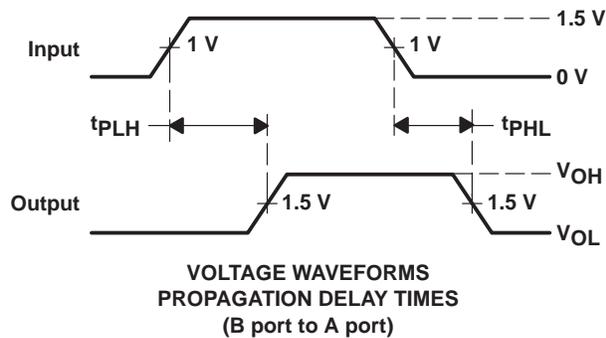
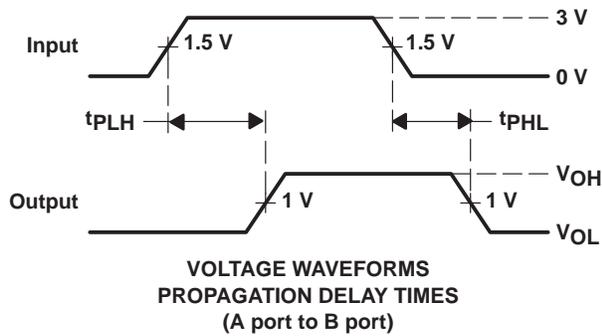


LOAD CIRCUIT FOR A OUTPUTS

TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



LOAD CIRCUIT FOR B OUTPUTS



- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.  
 C. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  10 MHz,  $Z_O = 50 \Omega$ , slew rate  $\leq$  1 V/ns.  
 D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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# SN74GTLPH306

## 8-BIT LVTTL-TO-GTL+ BUS TRANSCEIVER

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### DISTRIBUTED-LOAD BACKPLANE SWITCHING CHARACTERISTICS

This data sheet is specified for and tested to the lump load shown in Figure 1. However, the designer probably uses this GTLP device in a distributed load like that shown in Figure 2, in which actual B-port backplane switching characteristics are different. Therefore, the device is modeled as shown in Figure 3, which very closely matches the results obtained using Figure 2. Switching characteristics based on Figure 3 more closely match actual backplane design requirements.

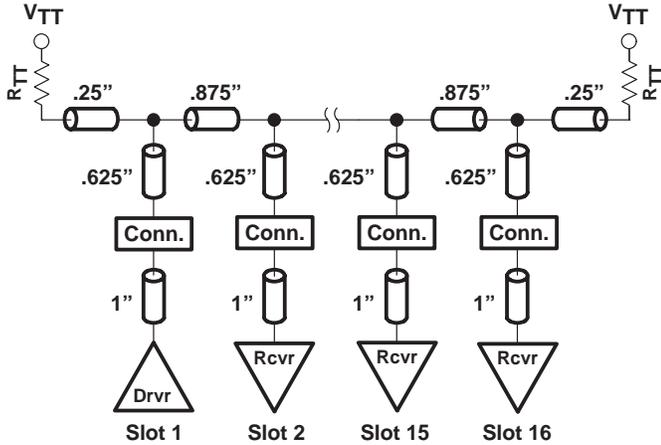


Figure 2. Test Backplane Model

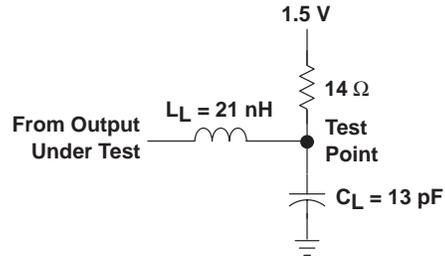


Figure 3. Distributed-Load Circuit for B Outputs

switching characteristics over recommended ranges of supply voltage and operating free-air temperature,  $V_{TT} = 1.5 \text{ V}$  and  $V_{REF} = 1 \text{ V}$  for GTL+ (see Figure 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	TYP†	MAX	UNIT
$t_{PHL}$	A	B				ns
$t_{PLH}$						
$t_{en}$	OE	B				ns
$t_{dis}$						
$t_r$	Rise time, B outputs (20% to 80%)					ns
$t_f$	Fall time, B outputs (80% to 20%)					ns

† All typical values are at  $V_{CC} = 3.3 \text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

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